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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

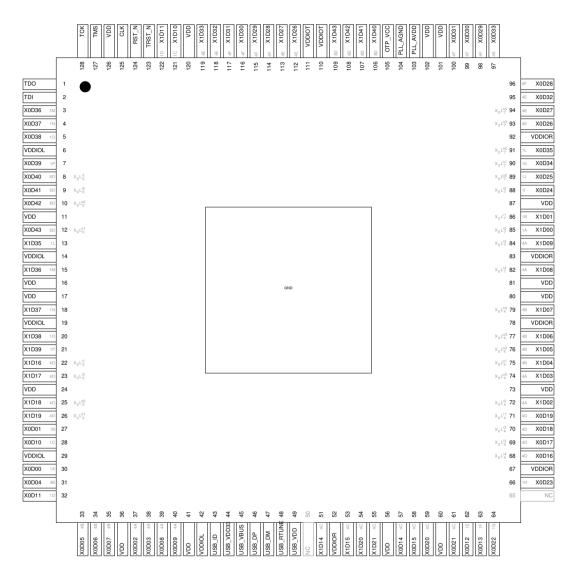
#### Details

Product Status	Active
Core Processor	XCore
Core Size	32-Bit 10-Core
Speed	2000MIPS
Connectivity	USB
Peripherals	-
Number of I/O	81
Program Memory Size	-
Program Memory Type	ROMIess
EEPROM Size	-
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	0.95V ~ 3.6V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	128-TQFP Exposed Pad
Supplier Device Package	128-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/xmos/xu210-512-tq128-i20

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

# 3 Pin Configuration



## 4 Signal Description

This section lists the signals and I/O pins available on the XU210-512-TQ128. The device provides a combination of 1 bit, 4bit, 8bit and 16bit ports, as well as wider ports that are fully or partially (gray) bonded out. All pins of a port provide either output or input, but signals in different directions cannot be mapped onto the same port.

Pins may have one or more of the following properties:

- PD/PU: The IO pin has a weak pull-down or pull-up resistor. The resistor is enabled during and after reset. Enabling a link or port that uses the pin disables the resistor. Thereafter, the resistor can be enabled or disabled under software control. The resistor is designed to ensure defined logic input state for unconnected pins. It should not be used to pull external circuitry. Note that the resistors are highly non-linear and only a maximum pull current is specified in Section 13.2.
- ST: The IO pin has a Schmitt Trigger on its input.
- IOL/IOT/IOR: The IO pin is powered from VDDIOL, VDDIOT, and VDDIOR respectively

	Power pins (10)					
Signal	Function	Туре	Properties			
GND	Digital ground	GND				
OTP_VCC	OTP power supply	PWR				
PLL_AGND	Analog ground for PLL	PWR				
PLL_AVDD	Analog PLL power	PWR				
USB_VDD	Digital tile power	PWR				
USB_VDD33	USB Analog power	PWR				
VDD	Digital tile power	PWR				
VDDIOL	Digital I/O power (left)	PWR				
VDDIOR	Digital I/O power (right)	PWR				
VDDIOT	Digital I/O power (top)	PWR				

	JTAG pins (6)					
Signal	Function	Туре	Properties			
RST_N	Global reset input	Input	IOL, PU, ST			
тск	Test clock	Input	IOL, PD, ST			
TDI	Test data input	Input	IOL, PU			
TDO	Test data output	Output	IOL, PD			
TMS	Test mode select	Input	IOL, PU			
TRST_N	Test reset input	Input	IOL, PU, ST			

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Signal	Function					Туре	Properties
X0D41	X <sub>0</sub> L0 <sup>0</sup>		8D <sup>5</sup>	16B <sup>13</sup>		1/0	IOL, PD
X0D42	X <sub>0</sub> L0 <sup>0</sup> <sub>out</sub>		8D <sup>6</sup>	16B <sup>14</sup>		I/O	IOL, PD
X0D43	X <sub>0</sub> L0 <sup>1</sup>		8D <sup>7</sup>	16B <sup>15</sup>		I/O	IOL, PD
X1D00	$X_0L7_{in}^2$ 1A <sup>0</sup>					I/O	IOR, PD
X1D01	$X_0L7_{in}^1$ 1B <sup>0</sup>					I/O	IOR, PD
X1D02	X <sub>0</sub> L4 <sup>0</sup>	4A <sup>0</sup>	8A <sup>0</sup>	16A <sup>0</sup>	32A <sup>20</sup>	I/O	IOR, PD
X1D03	X <sub>0</sub> L4 <sup>0</sup> <sub>out</sub>	4A <sup>1</sup>	8A <sup>1</sup>	16A <sup>1</sup>	32A <sup>21</sup>	I/O	IOR, PD
X1D04	X <sub>0</sub> L4 <sup>1</sup> <sub>out</sub>	4B <sup>0</sup>	8A <sup>2</sup>	16A <sup>2</sup>	32A <sup>22</sup>	I/O	IOR, PD
X1D05	X <sub>0</sub> L4 <sup>2</sup> <sub>out</sub>	4B <sup>1</sup>	8A <sup>3</sup>	16A <sup>3</sup>	32A <sup>23</sup>	I/O	IOR, PD
X1D06	X <sub>0</sub> L4 <sup>3</sup> <sub>out</sub>	4B <sup>2</sup>	8A <sup>4</sup>	16A <sup>4</sup>	32A <sup>24</sup>	I/O	IOR, PD
X1D07	X <sub>0</sub> L4 <sup>4</sup> <sub>out</sub>	4B <sup>3</sup>	8A <sup>5</sup>	16A <sup>5</sup>	32A <sup>25</sup>	I/O	IOR, PD
X1D08	X <sub>0</sub> L7 <sup>4</sup> <sub>in</sub>	4A <sup>2</sup>	8A <sup>6</sup>	16A <sup>6</sup>	32A <sup>26</sup>	I/O	IOR, PD
X1D09	X <sub>0</sub> L7 <sup>3</sup> <sub>in</sub>	4A <sup>3</sup>	8A <sup>7</sup>	16A <sup>7</sup>	32A <sup>27</sup>	I/O	IOR, PD
X1D10	1C <sup>0</sup>					I/O	IOT, PD
X1D11	1D <sup>0</sup>					I/O	IOT, PD
X1D14		4C <sup>0</sup>	8B <sup>0</sup>	16A <sup>8</sup>	32A <sup>28</sup>	I/O	IOR, PD
X1D15		4C <sup>1</sup>	8B1	16A <sup>9</sup>	32A <sup>29</sup>	I/O	IOR, PD
X1D16	X <sub>0</sub> L3 <sup>1</sup> <sub>in</sub>	4D <sup>0</sup>	8B <sup>2</sup>	16A <sup>10</sup>		I/O	IOL, PD
X1D17	X <sub>0</sub> L3 <sup>0</sup> <sub>in</sub>	4D <sup>1</sup>	8B <sup>3</sup>	16A <sup>11</sup>		I/O	IOL, PD
X1D18	X <sub>0</sub> L3 <sup>0</sup> <sub>out</sub>	4D <sup>2</sup>	8B <sup>4</sup>	16A <sup>12</sup>		I/O	IOL, PD
X1D19	X <sub>0</sub> L3 <sup>1</sup> <sub>out</sub>	4D <sup>3</sup>	8B <sup>5</sup>	16A <sup>13</sup>		I/O	IOL, PD
X1D20		4C <sup>2</sup>	8B <sup>6</sup>	16A <sup>14</sup>	32A <sup>30</sup>	I/O	IOR, PD
X1D21		4C <sup>3</sup>	8B <sup>7</sup>	16A <sup>15</sup>	32A <sup>31</sup>	I/O	IOR, PD
X1D26		4E <sup>0</sup>	8C <sup>0</sup>	16B <sup>0</sup>		I/O	IOT, PD
X1D27		4E <sup>1</sup>	8C1	16B <sup>1</sup>		I/O	IOT, PD
X1D28		4F <sup>0</sup>	8C <sup>2</sup>	16B <sup>2</sup>		I/O	IOT, PD
X1D29		4F <sup>1</sup>	8C <sup>3</sup>	16B <sup>3</sup>		I/O	IOT, PD
X1D30		4F <sup>2</sup>	8C <sup>4</sup>	16B <sup>4</sup>		I/O	IOT, PD
X1D31		4F <sup>3</sup>	8C <sup>5</sup>	16B <sup>5</sup>		I/O	IOT, PD
X1D32		4E <sup>2</sup>	8C <sup>6</sup>	16B <sup>6</sup>		I/O	IOT, PD
X1D33		4E <sup>3</sup>	8C <sup>7</sup>	16B <sup>7</sup>		I/O	IOT, PD
X1D35	1L <sup>0</sup>					I/O	IOL, PD
X1D36	1 M <sup>0</sup>		8D <sup>0</sup>	16B <sup>8</sup>		I/O	IOL, PD
X1D37	1 N <sup>0</sup>		8D <sup>1</sup>	16B <sup>9</sup>		I/O	IOL, PD
X1D38	100		8D <sup>2</sup>	16B <sup>10</sup>		I/O	IOL, PD
X1D39	1 P <sup>0</sup>		8D <sup>3</sup>	16B <sup>11</sup>		I/O	IOL, PD
X1D40			8D <sup>4</sup>	16B <sup>12</sup>		I/O	IOT, PD
X1D41			8D <sup>5</sup>	16B <sup>13</sup>		I/O	IOT, PD
X1D42			8D <sup>6</sup>	16B <sup>14</sup>		I/O	IOT, PD
X1D43			8D <sup>7</sup>	16B <sup>15</sup>		I/O	IOT, PD

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## 6 Product Overview

The XU210-512-TQ128 is a powerful device that consists of two xCORE Tiles, each comprising a flexible logical processing cores with tightly integrated I/O and on-chip memory.

#### 6.1 Logical cores

Each tile has up to 5 active logical cores, which issue instructions down a shared five-stage pipeline. Instructions from the active cores are issued round-robin. Each core is allocated a fifth of the processing cycles. Figure 3 shows the guaranteed core performance.

Figure 3: Logical core	Speed grade	MIPS	Frequency	MIPS per logical core
performance	10	1000 MIPS	500 MHz	100

There is no way that the performance of a logical core can be reduced below these predicted levels (unless *priority threads* are used: in this case the guaranteed minimum performance is computed based on the number of priority threads as defined in the architecture manual).

The logical cores are triggered by events instead of interrupts and run to completion. A logical core can be paused to wait for an event.

## 6.2 xTIME scheduler

The xTIME scheduler handles the events generated by xCORE Tile resources, such as channel ends, timers and I/O pins. It ensures that all events are serviced and synchronized, without the need for an RTOS. Events that occur at the I/O pins are handled by the Hardware-Response ports and fed directly to the appropriate xCORE Tile. An xCORE Tile can also choose to wait for a specified time to elapse, or for data to become available on a channel.

Tasks do not need to be prioritised as each of them runs on their own logical xCORE. It is possible to share a set of low priority tasks on a single core using cooperative multitasking.

## 6.3 Hardware Response Ports

Hardware Response ports connect an xCORE tile to one or more physical pins and as such define the interface between hardware attached to the XU210-512-TQ128, and the software running on it. A combination of 1bit, 4bit, 8bit, 16bit and 32bit ports are available. All pins of a port provide either output or input. Signals in different directions cannot be mapped onto the same port.

The port logic can drive its pins high or low, or it can sample the value on its pins, optionally waiting for a particular condition. Ports are accessed using dedicated instructions that are executed in a single processor cycle. xCORE-200 IO pins can



The pins used for SPI boot are hardcoded in the boot ROM and cannot be changed. If required, an SPI boot program can be burned into OTP that uses different pins.

#### 8.3 Boot from SPI slave

If set to boot from SPI slave, the processor enables the three pins specified in Figure 12 and expects a boot image to be clocked in. The supported clock polarity and phase are 0/0 and 1/1.

Figure 12: SPI slave pins

Pin	Signal	Description
X0D00	SS	Slave Select
X0D10	SCLK	Clock
X0D11	MOSI	Master Out Slave In (Data)

The xCORE Tile expects each byte to be transferred with the *least-significant bit first*. The pins used for SPI boot are hardcoded in the boot ROM and cannot be changed. If required, an SPI boot program can be burned into OTP that uses different pins.

#### 8.4 Boot from xConnect Link

If set to boot from an xConnect Link, the processor enables its link(s) around 2 us after the boot process starts. Enabling the Link switches off the pull-down resistors on the link, drives all the TX wires low (the initial state for the Link), and monitors the RX pins for boot-traffic; they must be low at this stage. If the internal pull-down is too weak to drain any residual charge, external pull-downs of 10K may be required on those pins.

The boot-rom on the core will then:

- 1. Allocate channel-end 0.
- 2. Input a word on channel-end 0. It will use this word as a channel to acknowledge the boot. Provide the null-channel-end 0x0000FF02 if no acknowledgment is required.
- 3. Input the boot image specified above, including the CRC.
- 4. Input an END control token.
- 5. Output an END control token to the channel-end received in step 2.
- 6. Free channel-end 0.
- 7. Jump to the loaded code.

#### 8.5 Boot from OTP

If an xCORE tile is set to use secure boot (see Figure 8), the boot image is read from address 0 of the OTP memory in the tile's security module.

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Each tile has its own individual OTP memory, and hence some tiles can be booted from OTP while others are booted from SPI or the channel interface. This enables systems to be partially programmed, dedicating one or more tiles to perform a particular function, leaving the other tiles user-programmable.

#### 8.6 Security register

secret decryption keys.

The security register enables security features on the xCORE tile. The features shown in Figure 13 provide a strong level of protection and are sufficient for providing strong IP security.

Feature	Bit	Description
Disable JTAG	0	The JTAG interface is disabled, making it impossible for the tile state or memory content to be accessed via the JTAG interface.
Disable Link access	1	Other tiles are forbidden access to the processor state via the system switch. Disabling both JTAG and Link access transforms an xCORE Tile into a "secure island" with other tiles free for non-secure user application code.
Secure Boot	5	The xCORE Tile is forced to boot from address 0 of the OTP, allowing the xCORE Tile boot ROM to be bypassed ( <i>see</i> $\S$ 8).
Redundant rows	7	Enables redundant rows in OTP.
Sector Lock 0	8	Disable programming of OTP sector 0.
Sector Lock 1	9	Disable programming of OTP sector 1.
Sector Lock 2	10	Disable programming of OTP sector 2.
Sector Lock 3	11	Disable programming of OTP sector 3.
OTP Master Lock	12	Disable OTP programming completely: disables updates to all sectors and security register.
Disable JTAG-OTP	13	Disable all (read & write) access from the JTAG interface to this OTP.
	2115	General purpose software accessable security register available to end-users.
	3122	General purpose user programmable JTAG UserID code extension.

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Figure 13: Security register features

## 9 Memory

#### 9.1 OTP

Each xCORE Tile integrates 8 KB one-time programmable (OTP) memory along with a security register that configures system wide security features. The OTP holds data in four sectors each containing 512 rows of 32 bits which can be used to implement secure bootloaders and store encryption keys. Data for the security register is loaded from the OTP on power up. All additional data in OTP is copied from the OTP to SRAM and executed first on the processor.

The OTP memory is programmed using three special I/O ports: the OTP address port is a 16-bit port with resource ID 0x100200, the OTP data is written via a 32-bit port with resource ID 0x200100, and the OTP control is on a 16-bit port with ID 0x100300. Programming is performed through libotp and xburn.

#### 9.2 SRAM

Each xCORE Tile integrates a single 256KBSRAM bank for both instructions and data. All internal memory is 32 bits wide, and instructions are either 16-bit or 32-bit. Byte (8-bit), half-word (16-bit) or word (32-bit) accesses are supported and are executed within one tile clock cycle. There is no dedicated external memory interface, although data memory can be expanded through appropriate use of the ports.

## 10 USB PHY

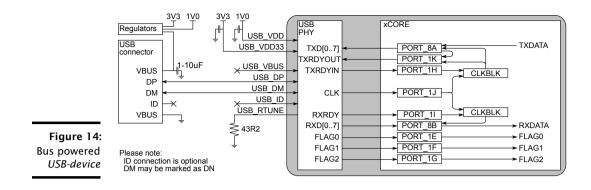
The USB PHY provides High-Speed and Full-Speed, device, host, and on-the-go functionality. The PHY is configured through a set of peripheral registers (Appendix F), and data is communicated through ports on the digital node. A library, XUD, is provided to implement *USB-device* functionality.

The USB PHY is connected to the ports on Tile 0 and Tile 1 as shown in Figure 14. When the USB PHY is enabled on Tile 0, the ports shown can on Tile 0 only be used with the USB PHY. When the USB PHY is enabled on Tile 1, then the ports shown can on Tile 1 only be used with the USB PHY. All other IO pins and ports are unaffected. The USB PHY should not be enabled on both tiles. Two clock blocks can be used to clock the USB ports. One clock block for the TXDATA path, and one clock block for the RXDATA path. Details on how to connect those ports are documented in an application note on USB for xCORE-200.

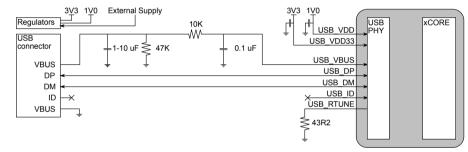
An external resistor of 43.2 ohm (1% tolerance) should connect USB\_RTUNE to ground, as close as possible to the device.

#### 10.1 USB VBUS

USB\_VBUS need not be connected if the device is wholly powered by USB, and the device is used to implement a *USB-device*.



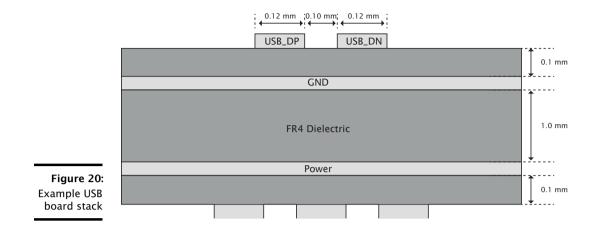
If you use the USB PHY to design a self-powered *USB-device*, then the device must be able detect the presence of VBus on the USB connector (so the device can disconnect its pull-up resistors from D+/D- to ensure the device does not have any voltage on the D+/D- pins when VBus is not present, "USB Back Voltage Test"). This requires USB\_VBUS to be connected to the VBUS pin of the USB connector as is shown in Figure 15.





When connecting a USB cable to the device it is possible an overvoltage transient will be present on VBus due to the inductance of the USB cable combined with the required input capacitor on VBus. The circuit in Figure 15 ensures that the transient does not damage the device. The 10k series resistor and 0.1 uF capacitor ensure than any input transient is filtered and does not reach the device. The 47k resistor to ground is a bleeder resistor to discharge the input capacitor when VBus is not present. The 1-10 uF input capacitor is required as part of the USB specification. A typical value would be 2.2 uF to ensure the 1 uF minimum requirement is met even under voltage bias conditions.

In any case, extra components (such as a ferrite bead and diodes) may be required for EMC compliance and ESD protection. Different wiring is required for USB-host and USB-OTG.



Reference planes should be below the transmission lines in order to maintain control of the trace impedance.

We recommend that the high-speed clock and high-speed USB differential pairs are routed first before any other routing. When routing high speed USB signals, the following guidelines should be followed:

- ▶ High speed differential pairs should be routed together.
- ▶ High-speed USB signal pair traces should be trace-length matched. Maximum trace-length mismatch should be no greater than 4mm.
- ▶ Ensure that high speed signals (clocks, USB differential pairs) are routed as far away from off-board connectors as possible.
- ▶ High-speed clock and periodic signal traces that run parallel should be at least 1.27mm away from USB\_DP/USB\_DN (see Figure 19).
- Low-speed and non-periodic signal traces that run parallel should be at least 0.5mm away from USB\_DP/USB\_DN (see Figure 19).
- ▶ Route high speed USB signals on the top of the PCB wherever possible.
- Route high speed USB traces over continuous power planes, with no breaks. If a trade-off must be made, changing signal layers is preferable to crossing plane splits.
- Follow the  $20 \times h$  rule; keep traces  $20 \times h$  (the height above the power plane) away from the edge of the power plane.
- ▶ Use a minimum of vias in high speed USB traces.
- Avoid corners in the trace. Where necessary, rather than turning through a 90 degree angle, use two 45 degree turns or an arc.

# C Tile Configuration

The xCORE Tile control registers can be accessed using configuration reads and writes (use write\_tile\_config\_reg(tileref, ...) and read\_tile\_config\_reg(tileref,  $\rightarrow$  ...) for reads and writes).

Number	Perm	Description
0x00	CRO	Device identification
0x01	CRO	xCORE Tile description 1
0x02	CRO	xCORE Tile description 2
0x04	CRW	Control PSwitch permissions to debug registers
0x05	CRW	Cause debug interrupts
0x06	CRW	xCORE Tile clock divider
0x07	CRO	Security configuration
0x20 0x27	CRW	Debug scratch
0x40	CRO	PC of logical core 0
0x41	CRO	PC of logical core 1
0x42	CRO	PC of logical core 2
0x43	CRO	PC of logical core 3
0x44	CRO	PC of logical core 4
0x45	CRO	PC of logical core 5
0x46	CRO	PC of logical core 6
0x47	CRO	PC of logical core 7
0x60	CRO	SR of logical core 0
0x61	CRO	SR of logical core 1
0x62	CRO	SR of logical core 2
0x63	CRO	SR of logical core 3
0x64	CRO	SR of logical core 4
0x65	CRO	SR of logical core 5
0x66	CRO	SR of logical core 6
0x67	CRO	SR of logical core 7

Figure 35: Summary

## C.1 Device identification: 0x00

This register identifies the xCORE Tile

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	Bits	Perm	Init	Description
	31:24	CRO		Processor ID of this XCore.
0x00:	23:16	CRO		Number of the node in which this XCore is located.
Device	15:8	CRO		XCore revision.
identification	7:0	CRO		XCore version.

#### C.2 xCORE Tile description 1: 0x01

This register describes the number of logical cores, synchronisers, locks and channel ends available on this xCORE tile.

Bits	Perm	Init	Description
31:24	CRO		Number of channel ends.
23:16	CRO		Number of the locks.
15:8	CRO		Number of synchronisers.
7:0	RO	-	Reserved

0x01: xCORE Tile description 1

#### C.3 xCORE Tile description 2: 0x02

This register describes the number of timers and clock blocks available on this xCORE tile.

0x02: xCORE Tile description 2

	Bits	Perm	Init	Description
:02:	31:16	RO	-	Reserved
Tile	15:8	CRO		Number of clock blocks.
n 2	7:0	CRO		Number of timers.

## C.4 Control PSwitch permissions to debug registers: 0x04

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This register can be used to control whether the debug registers (marked with permission CRW) are accessible through the tile configuration registers. When this bit is set, write -access to those registers is disabled, preventing debugging of the xCORE tile over the interconnect.



0x41: PC of logical core 1

Bits	Perm	Init	Description
31:0	CRO		Value.

## C.11 PC of logical core 2: 0x42

Value of the PC of logical core 2.

0x42: PC of logical core 2

Bits	Perm	Init	Description
31:0	CRO		Value.

## C.12 PC of logical core 3: 0x43

Value of the PC of logical core 3.

0x43:				
PC of logical	Bits	Perm	Init	Description
core 3	31:0	CRO		Value.

## C.13 PC of logical core 4: 0x44

Value of the PC of logical core 4.

**0x44** PC of logical core 4

<b>0x44:</b> logical	Bits	Perm	Init	Description
core 4	31:0	CRO		Value.

## C.14 PC of logical core 5: 0x45

Value of the PC of logical core 5.

**0x45:** PC of logical core 5

). 	Bits	Perm	Init	Description	
5	31:0	CRO		Value.	

## **D** Node Configuration

The digital node control registers can be accessed using configuration reads and writes (use write\_node\_config\_reg(device, ...) and read\_node\_config\_reg(device,  $\rightarrow$  ...) for reads and writes).

Number	Perm	Description	
0x00	RO	Device identification	
0x01	RO	System switch description	
0x04	RW	Switch configuration	
0x05	RW	Switch node identifier	
0x06	RW	PLL settings	
0x07	RW	System switch clock divider	
0x08	RW	Reference clock	
0x09	R	System JTAG device ID register	
0x0A	R	System USERCODE register	
0x0C	RW	Directions 0-7	
0x0D	RW	Directions 8-15	
0x10	RW	Reserved	
0x11	RW	Reserved.	
0x1F	RO	Debug source	
0x20 0x28	RW	Link status, direction, and network	
0x40 0x47	RO	PLink status and network	
0x80 0x88	RW	Link configuration and initialization	
0xA0 0xA7	RW	Static link configuration	

Figure 36: Summary

## D.1 Device identification: 0x00

This register contains version and revision identifiers and the mode-pins as sampled at boot-time.

	Bits	Perm	Init	Description
	31:24	RO	-	Reserved
<b>0x00:</b> Device ntification	23:16	RO		Sampled values of BootCtl pins on Power On Reset.
	15:8	RO		SSwitch revision.
	7:0	RO		SSwitch version.

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## D.2 System switch description: 0x01

This register specifies the number of processors and links that are connected to this switch.

0x01 System switch description

	Bits	Perm	Init	Description
-	31:24	RO	-	Reserved
l:	23:16	RO		Number of SLinks on the SSwitch.
h	15:8	RO		Number of processors on the SSwitch.
n	7:0	RO		Number of processors on the device.

## D.3 Switch configuration: 0x04

This register enables the setting of two security modes (that disable updates to the PLL or any other registers) and the header-mode.

Bits	Perm	Init	Description	
31	RW	0	0 = SSCTL registers have write access. $1 = SSCTL$ registers can not be written to.	
30:9	RO	-	Reserved	
8	RW	0	$0 = PLL_CTL_REG$ has write access. $1 = PLL_CTL_REG$ can not be written to.	
7:1	RO	-	Reserved	
0	RW	0	0 = 2-byte headers, $1 = 1$ -byte headers (reset as 0).	

**0x04:** Switch configuration

## D.4 Switch node identifier: 0x05

This register contains the node identifier.

**0x05** Switch node identifier

:05:	Bits	Perm	Init	Description
ode	31:16	RO	-	Reserved
fier	15:0	RW	0	The unique ID of this node.

## D.5 PLL settings: 0x06

An on-chip PLL multiplies the input clock up to a higher frequency clock, used to clock the I/O, processor, and switch, see Oscillator. Note: a write to this register will cause the tile to be reset.

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Bits	Perm	Init	Description
31	RW		If set to 1, the chip will not be reset
30	RW		If set to 1, the chip will not wait for the PLL to re-lock. Only use this if a gradual change is made to the PLL
29	DW		If set to 1, set the PLL to be bypassed
28	DW		If set to 1, set the boot mode to boot from JTAG
27:26	RO	-	Reserved
25:23	RW		Output divider value range from 1 (8'h0) to 250 (8'hF9). P value.
22:21	RO	-	Reserved
20:8	RW		Feedback multiplication ratio, range from 1 (8'h0) to 255 (8'hFE). M value.
7	RO	-	Reserved
6:0	RW		Oscilator input divider value range from 1 (8'h0) to 32 (8'h0F). N value.

0x06: PLL settings

## D.6 System switch clock divider: 0x07

Sets the ratio of the PLL clock and the switch clock.

0x07 System switch clock divider

7: m	Bits	Perm	Init	Description
ck	31:16	RO	-	Reserved
er	15:0	RW	0	SSwitch clock generation

#### D.7 Reference clock: 0x08

Sets the ratio of the PLL clock and the reference clock used by the node.

0x08:	Bits	Perm	Init	Description
Reference clock	31:16	RO	-	Reserved
	15:0	RW	3	Software ref. clock divider

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## D.8 System JTAG device ID register: 0x09

**0x09:** System JTAG device ID register

	Bits	Perm	Init	Description
-	31:28	RO		
<b>9:</b> G	27:12	RO		
D	11:1	RO		
er	0	RO		

## D.9 System USERCODE register: 0x0A

**0x0A** System USERCODE register

A: n	Bits	Perm	Init	Description
E	31:18	RO		JTAG USERCODE value programmed into OTP SR
r؛	17:0	RO		metal fixable ID code

## D.10 Directions 0-7: 0x0C

This register contains eight directions, for packets with a mismatch in bits 7..0 of the node-identifier. The direction in which a packet will be routed is goverened by the most significant mismatching bit.

Bits	Perm	Init	Description		
31:28	RW	0	The direction for packets whose dimension is 7.		
27:24	RW	0	The direction for packets whose dimension is 6.		
23:20	RW	0	The direction for packets whose dimension is 5.		
19:16	RW	0	The direction for packets whose dimension is 4.		
15:12	RW	0	The direction for packets whose dimension is 3.		
11:8	RW	0	The direction for packets whose dimension is 2.		
7:4	RW	0	The direction for packets whose dimension is 1.		
3:0	RW	0	The direction for packets whose dimension is 0.		

0x0C: Directions 0-7

## D.11 Directions 8-15: 0x0D

This register contains eight directions, for packets with a mismatch in bits 15..8 of the node-identifier. The direction in which a packet will be routed is goverened by the most significant mismatching bit.

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Bits	Perm	Init	Description			
31:8	RO	-	Reserved			
7	RW	0	Set to 1 to enable XEVACKMODE mode.			
6	RW	0	Set to 1 to enable SOFISTOKEN mode.			
5	RW	0	Set to 1 to enable UIFM power signalling mode.			
4	RW	0	Set to 1 to enable IF timing mode.			
3	RO	-	Reserved			
2	RW	0	Set to 1 to enable UIFM linestate decoder.			
1	RW	0	Set to 1 to enable UIFM CHECKTOKENS mode.			
0	RW	0	Set to 1 to enable UIFM DOTOKENS mode.			

0x04: UIFM IFM control

#### F.3 UIFM Device Address: 0x08

The device address whose packets should be received. 0 until enumeration, it should be set to the assigned value after enumeration.

0x08: UIFM Device Address

	Bits	Perm	Init	Description
:	31:7	RO	-	Reserved
2	6:0	RW	0	The enumerated USB device address must be stored here. Only packets to this address are passed on.

## F.4 UIFM functional control: 0x0C

**0x0C:** UIFM functional control

	Bits	Perm	Init	Description
	31:5	RO	-	Reserved
:	4:2	RW	1	Set to 0 to disable UIFM to UTMI+ OPMODE mode.
	1	RW	1	Set to 1 to switch UIFM to UTMI+ TERMSELECT mode.
-	0	RW	1	Set to 1 to switch UIFM to UTMI+ XCVRSELECT mode.

## F.5 UIFM on-the-go control: 0x10

This register is used to negotiate an on-the-go connection.

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	Bits	Perm	Init	Description
0x2C:	31:4	RO	-	Reserved
UIFM PID	3:0	RO	0	Value of the last received PID.

#### F.13 UIFM Endpoint: 0x30

The last endpoint seen

**0x30:** UIFM Endpoint

	Bits	Perm	Init	Description	
0:	31:5	RO	-	Reserved	
и. И	4	RO	0	1 if endpoint contains a valid value.	
t	3:0	RO	0	A copy of the last received endpoint.	

#### F.14 UIFM Endpoint match: 0x34

This register can be used to mark UIFM endpoints as special.

**0x34:** UIFM Endpoint match

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RW	0	This register contains a bit for each endpoint. If its bit is set, the endpoint will be supplied on the RX port when ORed with $0x10$ .

## F.15 OTG Flags mask: 0x38

**0x38:** OTG Flags mask

<b>0x38:</b> Flags mask	Bits	Perm	Init	Description		
	31:0	RW	0	Data		

## F.16 UIFM power signalling: 0x3C

	Bits	Perm	Init	Description
0x3C:	31:9	RO	-	Reserved
<b>UIFM</b> power	8	RW	0	Valid
signalling	7:0	RW	0	Data

# H Schematics Design Check List

This section is a checklist for use by schematics designers using the XU210-512-TQ128. Each of the following sections contains items to check for each design.

#### H.1 Power supplies

- □ VDDIO and OTP\_VCC supply is within specification before the VDD (core) supply is turned on. Specifically, the VDDIO and OTP\_VCC supply is within specification before VDD (core) reaches 0.4V (Section 12).
- The VDD (core) supply ramps monotonically (rises constantly) from 0V to its final value (0.95V 1.05V) within 10ms (Section 12).
- The VDD (core) supply is capable of supplying 700 mA (Section 12 and Figure 22).
- PLL\_AVDD is filtered with a low pass filter, for example an RC filter, see Section 12

#### H.2 Power supply decoupling

- □ The design has multiple decoupling capacitors per supply, for example at least four0402 or 0603 size surface mount capacitors of 100nF in value, per supply (Section 12).
- □ A bulk decoupling capacitor of at least 10uF is placed on each supply (Section 12).

#### H.3 Power on reset

□ The RST\_N and TRST\_N pins are asserted (low) during or after power up. The device is not used until these resets have taken place.

#### H.4 Clock

- The CLK input pin is supplied with a clock with monotonic rising edges and low jitter.
- □ You have chosen an input clock frequency that is supported by the device (Section 7).

# I PCB Layout Design Check List

✓ This section is a checklist for use by PCB designers using the XS2-U10A-512-TQ128. Each of the following sections contains items to check for each design.

## I.1 Ground Plane

- □ Multiple vias (eg, 9) have been used to connect the center pad to the PCB ground plane. These minimize impedance and conduct heat away from the device. (Section 12.4).
- □ Other than ground vias, there are no (or only a few) vias underneath or closely around the device. This create a good, solid, ground plane.

## I.2 Power supply decoupling

- $\Box$  The decoupling capacitors are all placed close to a supply pin (Section 12).
- $\Box$  The decoupling capacitors are spaced around the device (Section 12).
- □ The ground side of each decoupling capacitor has a direct path back to the center ground of the device.

## I.3 PLL\_AVDD

The PLL\_AVDD filter (especially the capacitor) is placed close to the PLL\_AVDD pin (Section 12).